



IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

Inventors: Tsu-Wei Ku et al. Attorney Docket No.: ARC-P002
Serial No.: 09/491,389 Group Art Unit: 2825
Filed: January 26, 2000 Examiner: Thompson, A.M.
Title: Method and Apparatus of Relative Datapath Cell Placement with Structure Bonding (Amended)

AMENDMENT UNDER 37 CFR §1.111

Commissioner of Patents and Trademarks
Alexandria, VA 22313-1450

Sir:

In Response to the Official Action dated April 10, 2003, please amend this application as follows:

Amendments to the Title begin on page 2 of this paper

Amendments to the Specification begin on page 3 of this paper.

Amendments to the Claims are reflected in the listing of claims which begins on page 5 of this paper.

Remarks/Arguments begin on page 9 of this paper.

Conclusion begin on page 13 of this paper.

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TITLE

Please amend the title of the invention to --Method and Apparatus of Relative Datapath Cell Placement with Structure Bonding--.